



LIGITEK ELECTRONICS CO.,LTD.  
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LED SMD



Lead-Free Parts

LG-192VY-CT-A01

**DATA SHEET**

SPEC NO : QW0905-LG-192VY-CT-A01

REV. : A

CREATED : 31 - Aug. - 2011



### Features:

1. Package in 8.0mm carrier tape on 7" diameter reel.
2. Compatible with automatic placement equipment.
3. Compatible with reflow solder process.

### Descriptions:

1. The LG-192 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
2. Besides, lightweight makes them ideal for miniature applications. etc.

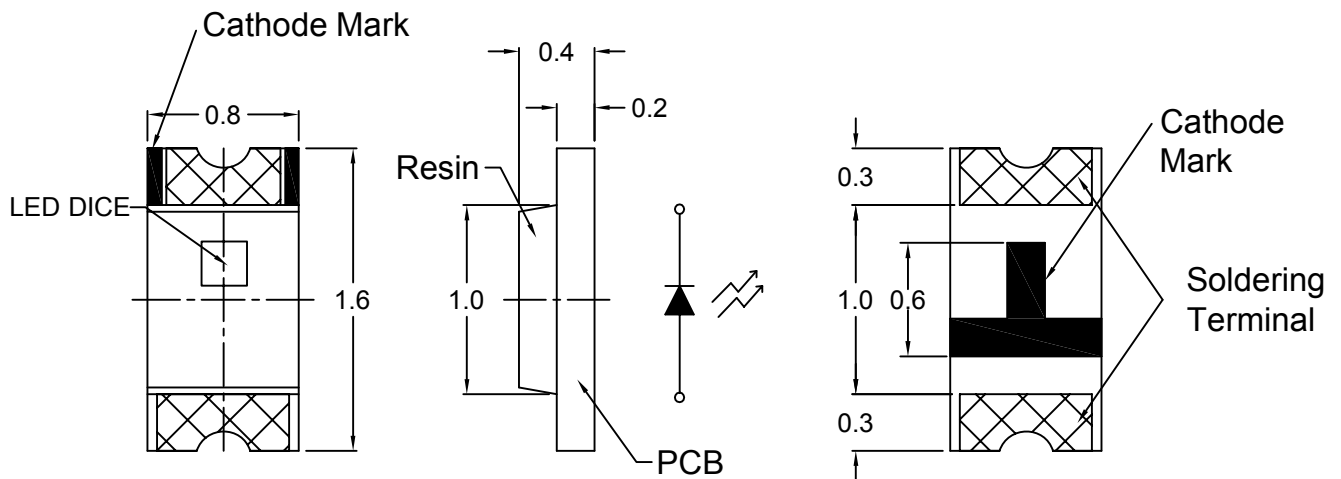
### Applications:

1. Automotive : backlighting in dashboard and switch.
2. Telecommunication : indicator and backlighting in telephone and fax.
3. Flat backlight for LCD, switch and symbol
4. General use.

### Device Selection Guide:

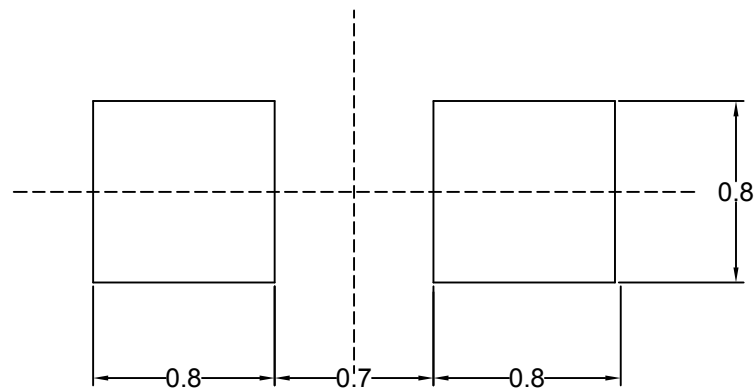
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LG-192VY-CT-A01	AlGaInP	Yellow	Water Clear

## Package Dimensions



Note : 1.All dimension are in millimeter tolerance is  $\pm 0.1$ mm unless otherwise noted.  
2.Specifications are subject to change without notice.

## Recommended Soldering Pad Dimensions



Note : The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5$ . Unit=mm.

### Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Ratings	UNIT
Power Dissipation	PD	78	mW
Peak Forward Current Duty 1/10@10KHz	IFP	60	mA
Forward Current	IF	30	mA
Reverse Current @5V	Ir	10	μA
Electrostatic Discharge	ESD	2000	V
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C

### Typical Electrical & Optical Characteristics (Ta=25 °C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION
Luminous Intensity	Iv	32	80	----	mcd	IF=20mA
Dominant Wavelength	λD	----	590	----	nm	IF=20mA
Spectral Line Half-Width	Δλ	----	20	----	nm	IF=20mA
Forward Voltage	V <sub>F</sub>	1.8	----	2.6	V	IF=20mA
Viewing Angle	2θ 1/2	----	110	----	deg	IF=20mA

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.  
2. The luminous intensity data did not including ±15% testing tolerance.

### Luminous Intensity Classification

BIN CODE	Iv(mcd) at20mA	
	Min.	Max.
P	50	80
Q	80	125

### Dominant Wavelength Classification

BIN CODE	$\lambda$ D(nm) at20mA	
	Min.	Max.
15	585	587
16	587	589
17	589	592
18	592	595
19	595	598

### Forward Voltage Classification

BIN CODE	Vf(v) at 20mA	
	Min.	Max.
1	1.8	2.0
2	2.0	2.2
3	2.2	2.4
4	2.4	2.6

**Typical Electro-Optical Characteristics Curve**

Fig.1 Forward current vs. Forward Voltage

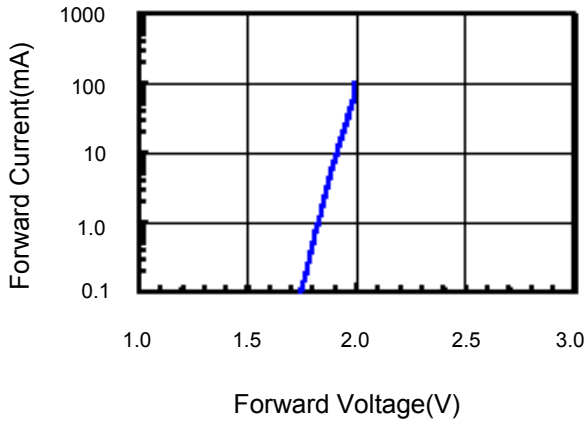


Fig.2 Relative Intensity vs. Forward Current

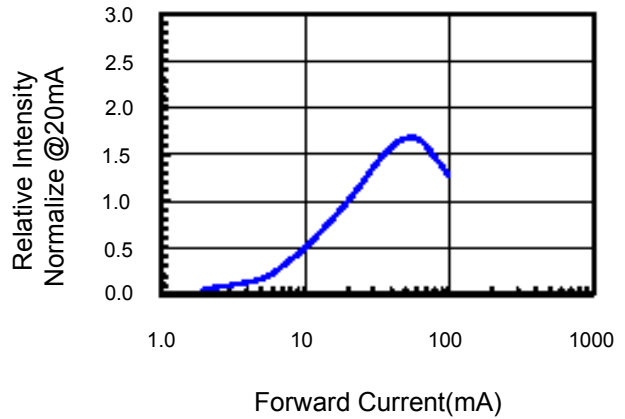


Fig.3 Forward Voltage vs. Temperature

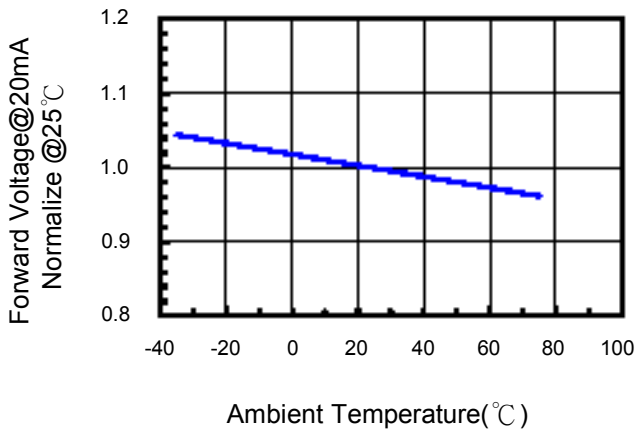


Fig.4 Relative Intensity vs. Temperature

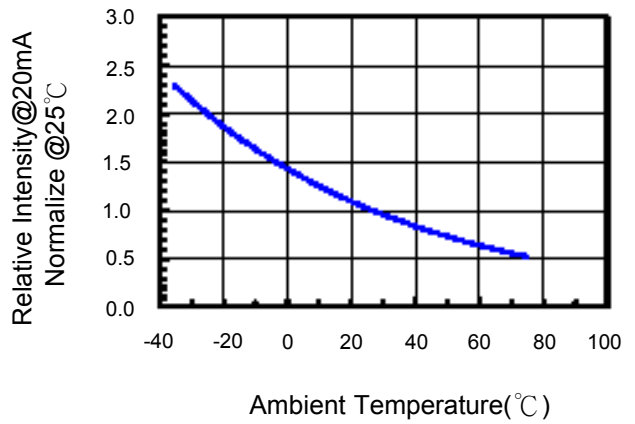


Fig.5 Relative Intensity vs. Wavelength

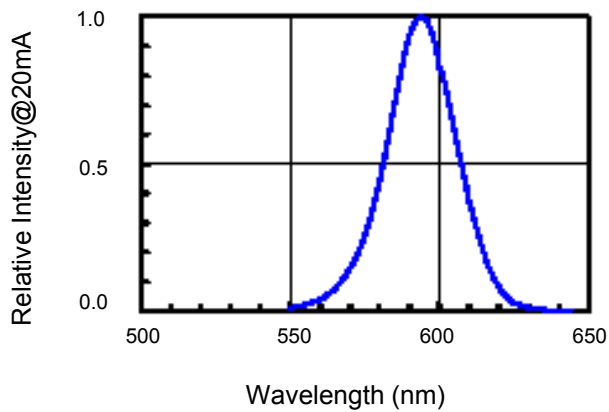
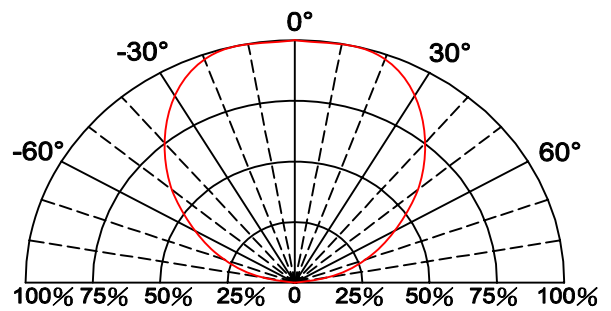
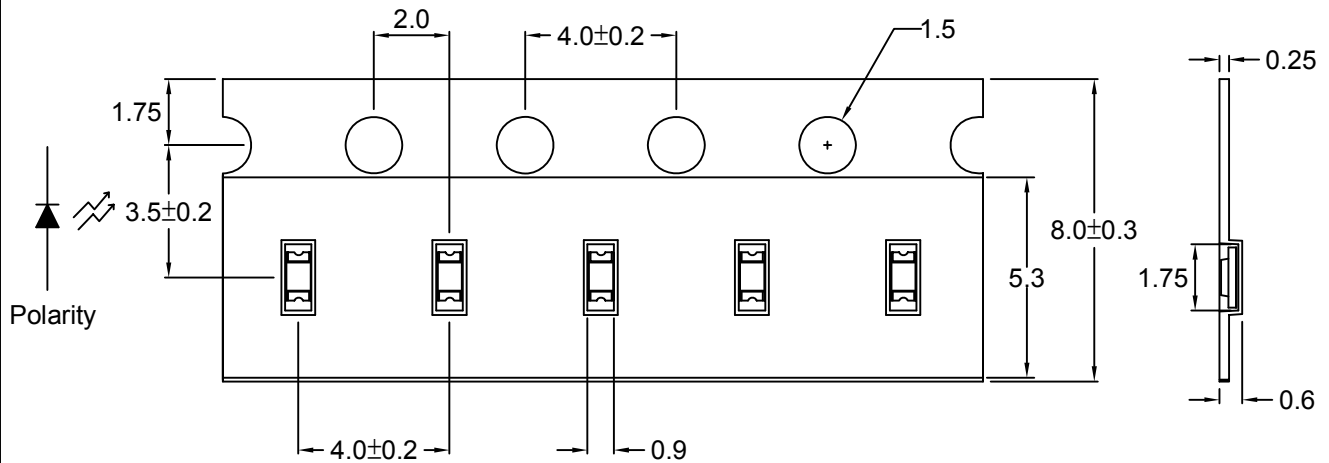


Fig.6 Directive Radiation

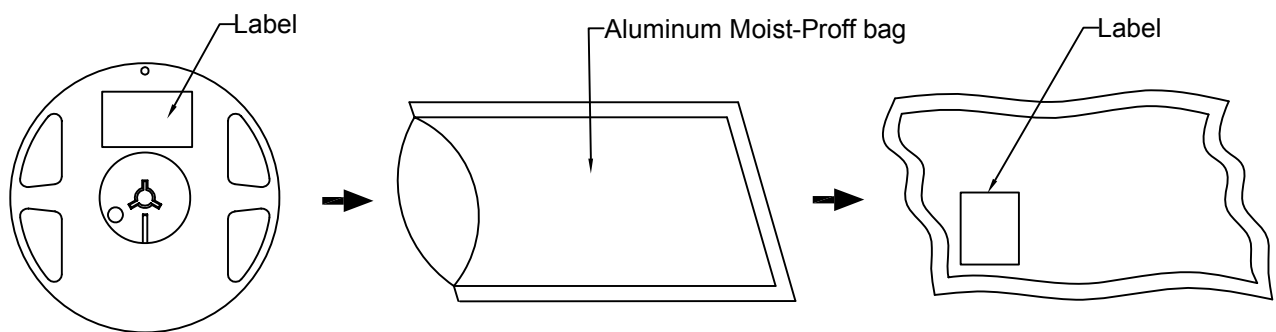


## Carrier Type Dimensions



Note : The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Angle  $\pm 0.5$ . Unit=mm.

### • Packing Specifications



Part No.	Description	Quantity/Reel
LG-192VY-CT-A01	8.0mm tape,7"reel	4000 devices

## Label Explanation

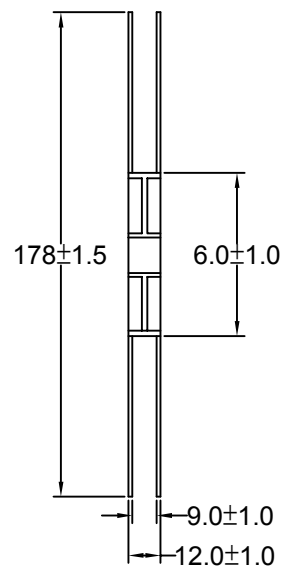
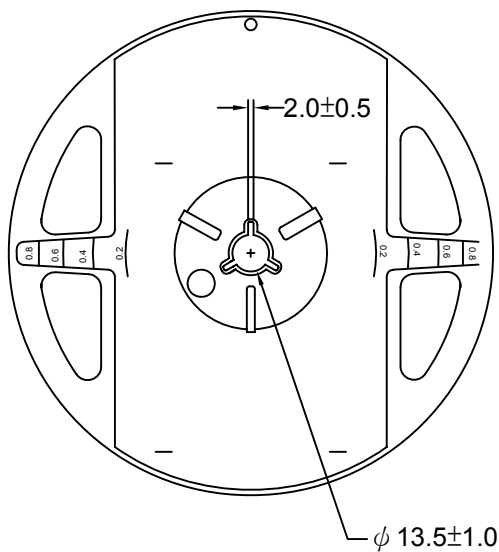
	LIGITEK ELECTRONICS CO., LTD.	
PART :	LG-192VY-CT-A01	
LOT :	GSI-080168	
QTY(PCS):	4000	
BIN/HUE :	P/17	VF:1.8-2.0

BIN : Luminous Intensity

HUE : Dominant Wavelength

VF : Forward Voltage

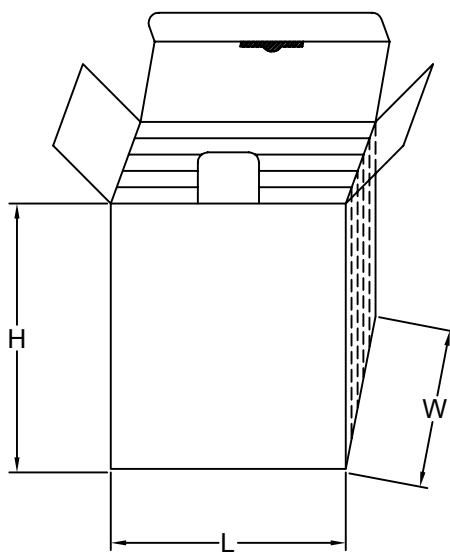
## Reel Dimensions



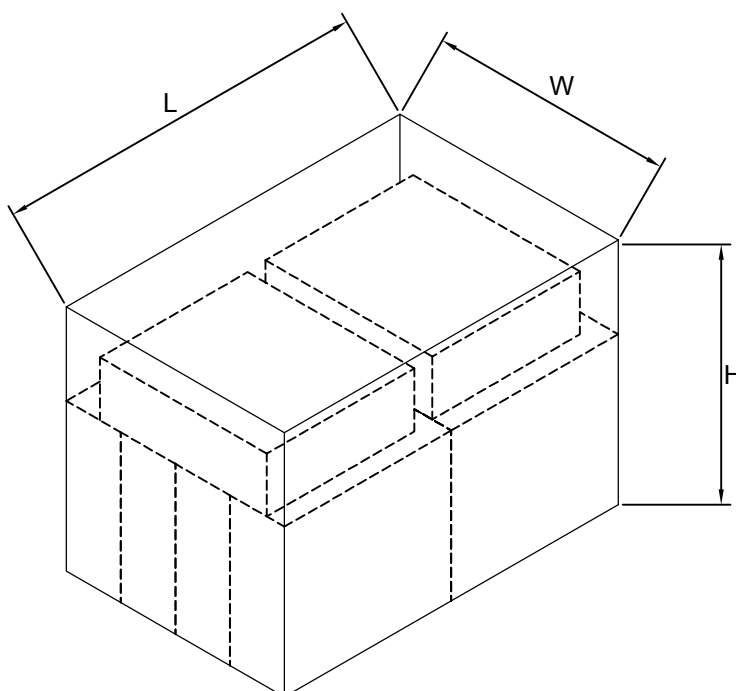


## Box Explanation

1. 5 BAG / INNER BOX
2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm

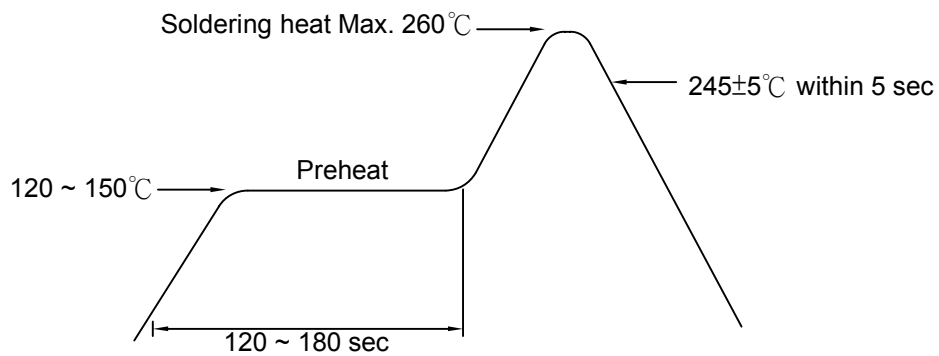
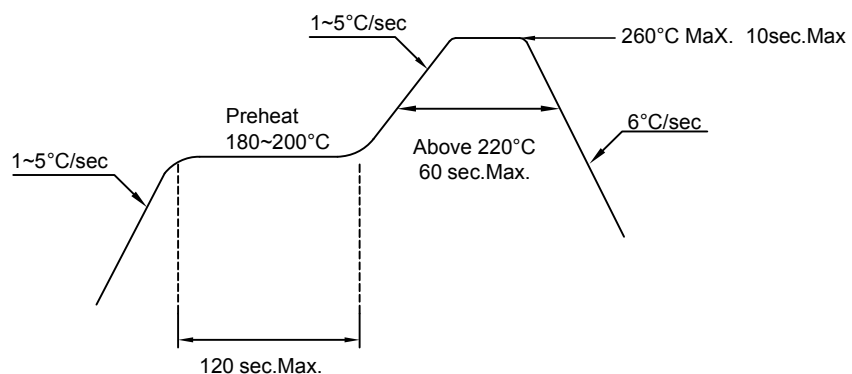


3. 10 INNER BOXES / CARTON
4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



**Recommended Soldering Conditions****1. Hand Solder**

Basic spec is  $\leq 280^{\circ}\text{C}$  3 sec one time only.

**2. Wave Solder****3. PB-Free Reflow Solder****Note:**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

**Precautions For Use:****Storage time:**

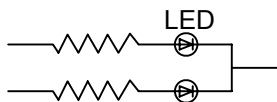
- 1.The operation of Temperatures and RH are :  $5^{\circ}\text{C}\sim 35^{\circ}\text{C}$  ,RH60%.
- 2.Once the package is opened, the products should be used within a week.  
Otherwise, they should be kept in a damp proof box with desiccating agent.  
Considering the tape life, we suggest our customers to use our products within a year(from production date).
- 3.If opened more than one week in an atmosphere  $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$  ,RH60%, they should be treated at  $60^{\circ}\text{C}\pm 5^{\circ}\text{C}$  for 15hrs.

**Drive Method:**

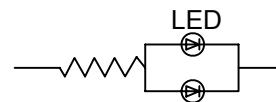
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

**Cleaning:**

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

**ESD(Electrostatic Discharge):**

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	MIL-STD-750D: 1026 MIL-STD-883D: 1005 JIS C 7021: B-1
	High Temperature Storage Test	1.Ta=105°C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	MIL-STD-883D:1008 JIS C 7021: B-10
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	JIS C 7021: B-12
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=65°C±5°C 3.RH=90%~95% 4.t=1000hrs; 02hrs	MIL-STD-202F:103B JIS C 7021: B-11
Environmental Test	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105°C±5°C & -40°C±5°C (10min) (10min) 3.total 10 cycles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1011
	Solder Resistance Test	1.T.Sol=260°C±5°C 2.Dwell Time= 10±1sec.	MIL-STD-202F: 210A MIL-STD-750D: 2031 JIS C 7021: A-1
	Solderability Test	1.T.Sol=235°C±5°C 2.Immersion time 2±0.5sec 3.Immersion rate 25±2.5mm/sec 4.Immersion rate 25±2.5mm/sec 5.Coverage ≥ 95% of the dipped surface	MIL-STD-202F: 208D MIL-STD-750D: 2026 MIL-STD-883D: 2003 IEC 68 Part 2-20 JIS C 7021: A-2
	Temperature Cycling	1.105°C ~ 25°C ~ 55°C ~ 25°C 30mins 5mins 30mins 5mins 2.10 Cycles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1010 JIS C 7021: A-4
	Solderability Test	Ramp-up rate(183°C to Peak) +3°C second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5-0°C Time within 5°C of actual Peak Temperature(tp) 10-30 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2 J-STD-020